TOSHIBA Photocoupler IRED & Photo-Triac

# TLP525G, TLP525G-2, TLP525G-4

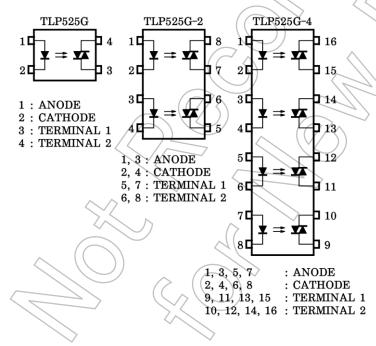
Triac Drive
Programmable Controllers
AC-Output Module
Solid State Relay

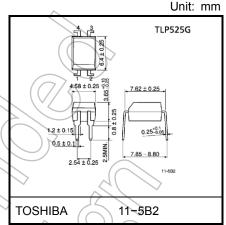
The TOSHIBA TLP525G, -2 and -4 consist of a photo–triac optically coupled to an infrared emitting diode.

The TLP525G-2 offers two isolated channels in an eight lead plastic DIP package, while the TLP525G-4 provides four isolated channels in a sixteen lead plastic DIP package.

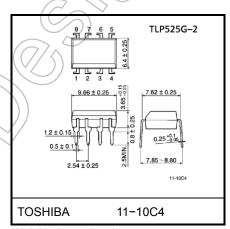
- Peak off-stage voltage: 400 V (min)
- Trigger LED current: 10 mA (max)
- Peak on-stage current: 2 Apk (max)
- Isolation voltage: 2500 V<sub>rms</sub> (min)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349

# Pin Configurations (top view)

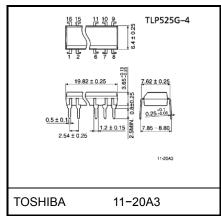




Weight: 0.26g (typ.)



Weight: 0.54g (typ.)



Weight: 1.1g (typ.)

Start of commercial production 1985-01

#### Absolute Maximum Ratings (Ta = 25°C)

				Ra			
	Characteristics		Symbol	TLP525G	TLP525G-2 TLP525G-4	Unit	
	Forward current		lF	50	50	mA	
	Forward current derating		I <sub>F</sub> / °C	-0.7 (Ta ≥ 53°C) -0.5 (Ta ≥ 25°C)		mA / °C	
	Pulse forward current		IFP	1 (100µs pu	Α		
Detector LED	Reverse voltage		V <sub>R</sub>	Į.	> V		
	Input power dissipation		PD	50	60	mW	
	Input power dissipation derating		ΔP <sub>D</sub> /°C	-0.69(Ta ≥ 53°C) -0.6(Ta ≥ 25°C)		mW/°C	
	Junction temperature		Tj	12	°C		
	Off-state output terminal voltage		V <sub>DRM</sub>	40	V		
	On state DMC surrent	Ta = 25°C	1	100	80	^	
	On-state RMS current	Ta = 70°C	TT (RMS)	50	mA		
_	On–state current derating (Ta ≥ 25°C)		I <sub>T</sub> / °C	-1.1	-0.9	mA/°C	
ecto	Peak on state current		ITP	2 (100µs pu	A		
Det	Peak non-repetitive surge current (P <sub>W</sub> = 10ms)		ITSM	1	A		
	Output power dissipation		Po	300	240	mW	
	Output power dissipation derating (Ta ≥ 25°C)		ΔP <sub>O</sub> /°C	-3.0 -2.4		mW / °C	
	Junction temperature		4	115		°C	
Stor	Storage temperature range		T <sub>stg</sub>	-55 to 125		°C	
Оре	Operating temperature range		Topr	-40 to 100		°C	
Lead soldering temperature		T <sub>sol</sub>	260 (10 s)		°C		
Isolation voltage (Note)		BVs	2500 (AC, 60 s, R.H. ≤ 60 %)		$V_{rms}$		

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note: Device considered a two terminal device: LED side pins shorted together and detector side pins shorted together.

### **Recommended Operating Conditions**

Characteristic	Symbol	Min	Тур.	Max	Unit
Supply voltage	VAC	_	_	120	Vac
Forward current	lF	15	20	25	mA
Peak on-state current	ITP	_	_	1	Α
Operating temperature	Topr	-25	_	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

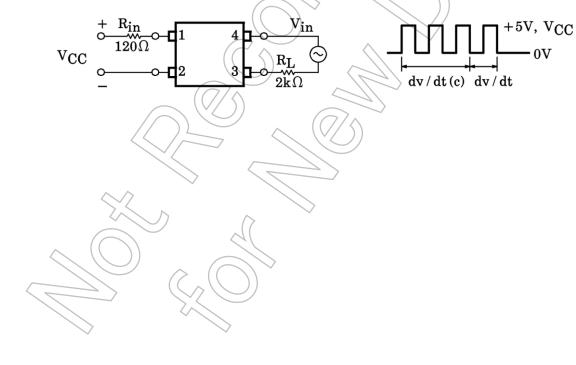
## **Individual Electrical Characteristics (Ta = 25°C)**

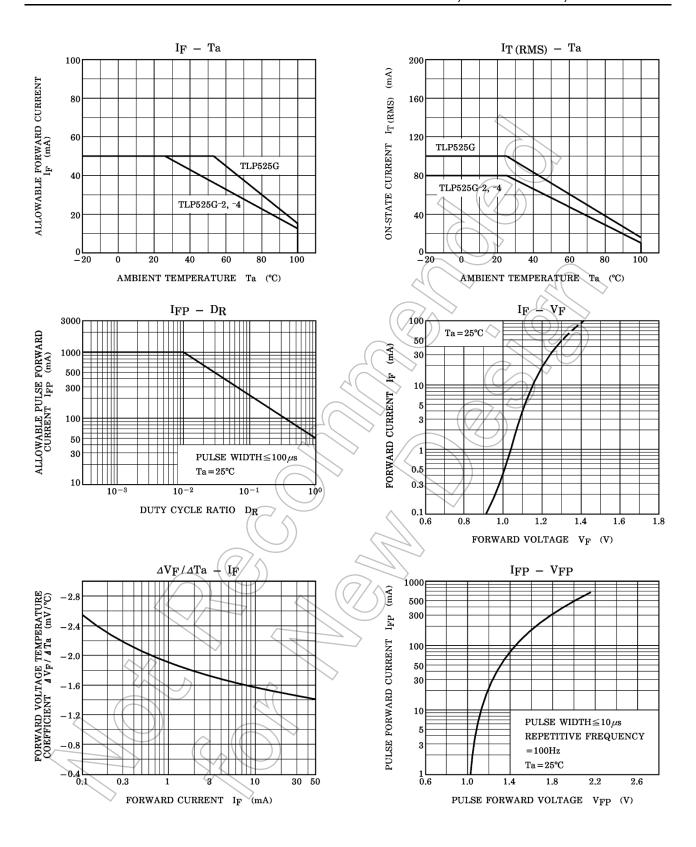
	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
LED	Forward voltage	VF	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	μΑ
	Capacitance	Ст	VF = 0 V, f = 1 MHz	_<	30	_	pF
	Peak off-state current	I <sub>DRM</sub>	V <sub>DRM</sub> = 400 V	- /	10	100	nA
Detector	Peak on-state voltage	V <sub>TM</sub>	I <sub>TM</sub> = 100 mA	- \	1.7	3.0	V
	Holding current	lΗ	_	(7)	0.6	_	mA
	Critical rate of rise of off–state voltage	dv / dt	V <sub>in</sub> = 120 V <sub>rms</sub> , Ta = 85 °C (Figure 1)	200	500	-	V / μs
	Critical rate of rise of commutating voltage	dv / dt (c)	V <sub>in</sub> = 30 V <sub>rms</sub> , I <sub>T</sub> = 15 mA (Figure 1)		0.2	_	V / μs

# Coupled Electrical Characteristics (Ta = 25°C)

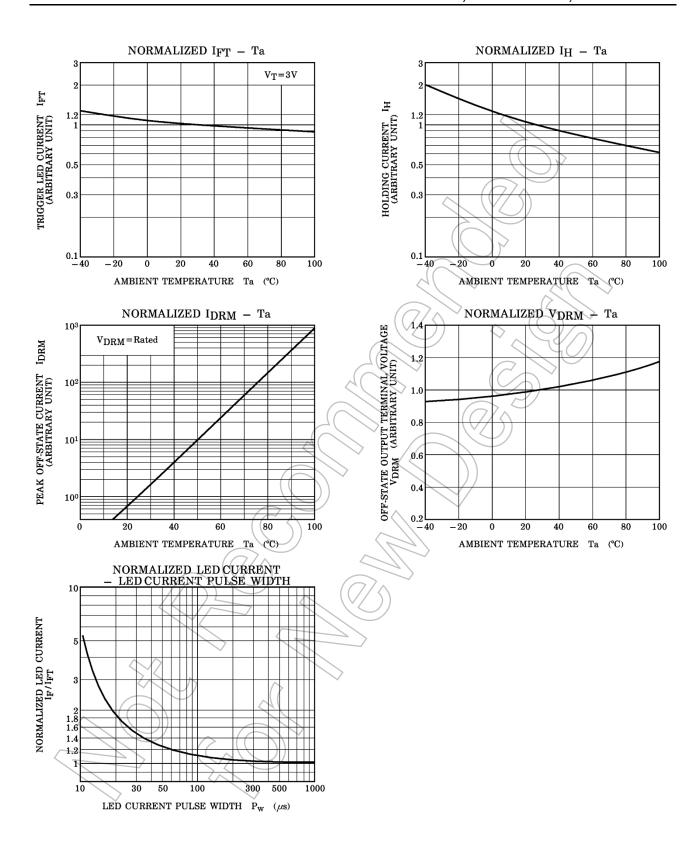
Characteristic	Symbol	Test Condition	Min. Typ.	Max.	Unit
Trigger LED current	lfT	V <sub>T</sub> = 3 V	- 5	10	mA
Capacitance input to output	Cs	V <sub>S</sub> = 0 V, f = 1 MHz	- 0.8	_	pF
Isolation resistance	Rs	V <sub>S</sub> = 500 V, R.H. ≤ 60 %	5×10 <sup>10</sup> 10 <sup>14</sup>		Ω
Isolation voltage	BVS	AC, 60 s	2500 —		Vrms

Fig.1 dv / dt Test Circuit





NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

#### **RESTRICTIONS ON PRODUCT USE**

Toshiba Corporation and its subsidiaries and affiliates are collectively referred to as "TOSHIBA". Hardware, software and systems described in this document are collectively referred to as "Product".

- TOSHIBA reserves the right to make changes to the information in this document and related Product without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE
  EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH
  MAY CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT
  ("UNINTENDED USE"). Except for specific applications as expressly stated in this document, Unintended Use includes, without
  limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, lifesaving and/or life supporting medical
  equipment, equipment used for automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to
  control combustions or explosions, safety devices, elevators and escalators, and devices related to power plant. IF YOU USE
  PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT. For details, please contact your
  TOSHIBA sales representative or contact us via our website.
- . Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any
  applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE
  FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY
  WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR
  LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND
  LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO
  SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS
  FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.
- GaAs (Gallium Arsenide) is used in Product. GaAs is harmful to humans if consumed or absorbed, whether in the form of dust or vapor. Handle with care and do not break, cut, crush, grind, dissolve chemically or otherwise expose GaAs in Product.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of
  Product. Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled
  substances, including without limitation, the EU RoHS Directive. TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES
  OCCURRING AS A RESULT OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.

### **TOSHIBA ELECTRONIC DEVICES & STORAGE CORPORATION**

https://toshiba.semicon-storage.com/

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Triac & SCR Output Optocouplers category:

Click to view products by Toshiba manufacturer:

Other Similar products are found below:

IL4218-X019 MOC3063S-TA ILD207-X001T ILD615-1X007T VO2223-X001 VO4254H WPPCT-N1066A WPPCT-N1566A WPPCT-Z546D 523170E WPPCT-Z546A WPPCT-Z1046D WPPCT-Z1046A WPPCT-N566D WPPCT-N566A WPPCT-N1566D FODM3053V\_NF098 VO4258D VO4256D VOM160R-X001T VO4158H-X017T VOM160P-X001T IL4116-X007 VO0601-X001T MOC3020XSM MOC3021X MOC3021XSM MOC3022X MOC3023SR2M MOC3041SM MOC3042XSM MOC3043SR2M MOC3043XSM MOC3052SM MOC3063X MOC3081X MOC3081XSM BRT12H-X001 IS620XSM IS623X VO3062-X007T VO3063-X006 MOC3020 MOC3020X MOC3022X MOC3022XSM MOC3023XSM MOC3023XSM MOC3021X